

XpressROM™ Users Guide

Revision History

Revision	Date	Comments
1.0	11/10/99	First Version
1.2	1/14/02	Second Revision
1.4	6/23/03	Third Revision
1.6	8/10/04	Fourth Revision
1.8	9/6/05	Fifth Revision
1.9	10/25/05	Post review

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Overview

The following document is a users guide for Insyde's XpressROM™ firmware for the AMD Geode™ processors including the AMD Geode™ NX, LX, GX ,SC1200, SC2200, SC3200, and GX1 processors. The user guide will show you the menu systems for the firmware and a mechanism for flashing the BIOS on your platform. Insyde has been working with AMD on the XpressROM™ firmware since 1999 and maintains a development relationship with AMD. Insyde also supports the entire line of AMD products including AMD Alchemy™ , AMD Athlon™, AMD Opteron™ ,AMD Turion™ AMD Sempron™ processors.

The Users Guide is applicable to all the AMD Geode™ processor reference designs with the following part numbers

LX/CS5536	GX/CS5536	GX/CS5535	SC1200/SC1201, SC2200,SC3200	SC1100	GX1
LX DB800	Geode GX SBC RDK	GX DB533 SP4GX2 Geode GX Thin Client	SP4SC30 SP4SC31 SP2SC20 DBSC1200	SP4SC40 DBSC1100	SP2GX10

Quick Start

1) Download the latest Evaluation Copy of XpressROM™

With reference platform from AMD, the next step is to load the latest XpressROM™ for the platform. To find the latest XpressROM™ for evaluation on the reference platform go to:

<http://www.insydetech.com/productcenter/amd/geodesite/index.cfm>

This website contains the latest released version of the XpressROM™ binary as well as a location to download boot loaders for the reference platforms.

2) Flash latest version of XpressROM™ on AMD platform

Now that you have the latest evaluation copy of XpressROM™, you must flash it onto your system by using either a flash prom burner or using a flash utility supplied by Insyde Software

If you do not have a copy of the flash utility, the website listed above contains a copy. Boot your system to DOS and then the command line to flash a xpress.rom image (256KB) of any size flash part (256/512/1024) is:

```
flashrom /D /sFFFC0000 xpress.rom
```

Where xpress.rom is the name of the binary you downloaded in step 1.

3) Clear CMOS

The next step is to boot your board and clear the CMOS. To clear the CMOS boot the platform and enter the setup by pressing F1 as the system is booting.

Select **L. Load Defaults** on the main menu

Next select **X. Save Values and Exit.**

4) Install OS and test system

The final step is to load the system with your operating system and test out the functionality.

Setup Menu Screens and Navigation

The XpressROM™ Setup Menu contains a number of features and options. It is recommend to evaluate the menu options prior to shipment of your platform to ensure the removal of options that could have a negative consequence if users change the items.

The controls for the setup menu are:

ESC	Back up menus or escape from a menu
Arrow Keys ↑↓	Scroll up and down menus and change radio boxes
Arrow Keys ←→	Scroll left and right in menus
<Enter> or <Return>	Select items in the menu or change status

Main Menu

The main menu is the first screen that appears from when a user selects **F1** during the boot process. Below is a screen shot of the main menu. Press the letter or use the arrow keys to select an option.

```

Version: Unknown Version          XpressROM Setup          Built:
Main Menu
A. Time 15:27:45
B. Date 10/20/2005
C. Motherboard Device Configuration
D. Memory and Cache Optimization
E. System Clock/PLL Configuration
F. Power Management
H. Miscellaneous Configuration
O. Boot Order

L. Load Defaults

S. Save Values Without Exit
Q. Exit Without Save
X. Save values and Exit

Set System Clocking and PLL values.
  
```

A. Changing the Time

To change the time select **A** from the main menu. You will be prompted with the following submenu

```

Main Menu/H. Time
Time:
TIME as HH:MM[:SS] <Seconds are optional>
  
```

Enter the time in the format listed as an example: 11:30:01 then hit <enter>

B. Changing the Date

To change the date select **B** form the main menu. You will be prompted with the following submenu:

```

Main Menu/B. Date
Date: _
Date as MM/DD/YYYY
  
```

Enter the date in the format listed as an example: 12/16/2005 then hit <enter>

C. Mother Board Device Configuration

The Mother Board Device configuration contains the only sub menu system of the setup screens. The choices are

Drive Configuration: Allows the configuration of the IDE drive

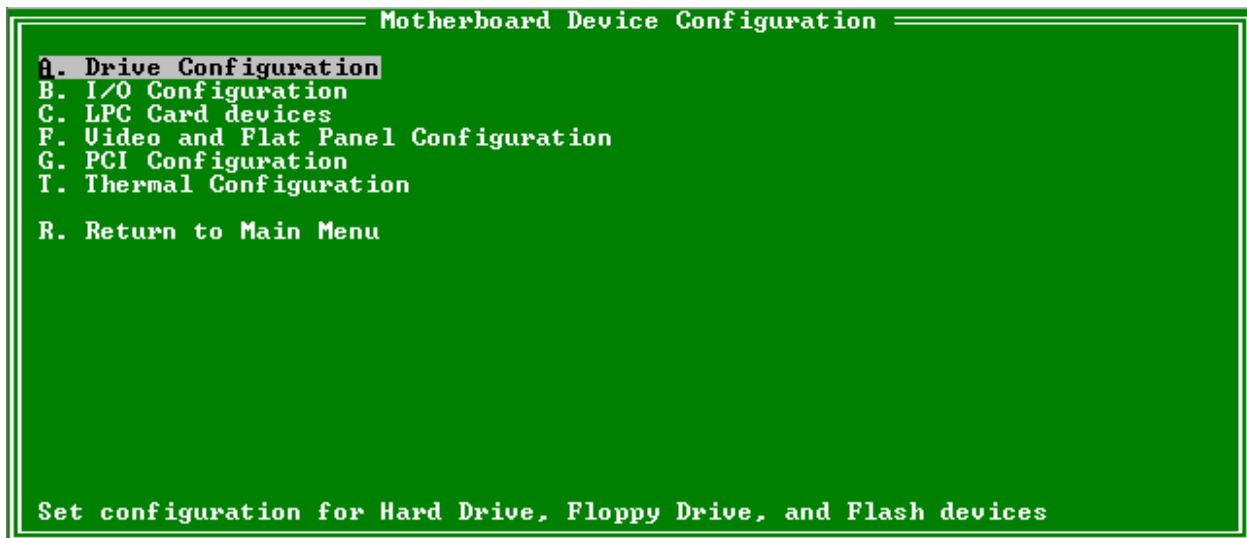
I/O Configuration: Allows for the configuration of the serial ports on the CS5535/CS5536

LPC card devices: Allows for the configuration of the serial and parallel ports on an LPC Card

Video and Flat Panel Configuration: Allows for the configuration of flat panels and video memory

PCI Configuration: Allows for the configuration of PCI devices (IRQ,USB)

Thermal Configuration: Allows for the configuration of the Thermal limits.



D. Memory and Cache Optimizations

The Memory and Cache Optimizations screen should not be left in a shipping system. Miss configuring the memory can render the system unable to boot. If the system is configured incorrectly, it may be necessary to short CMOS to get the system to boot.

Cache Enable: Allows the configuration of the Cache of the system to be either Enabled or Disabled

Cache Mode: Allows the selection of the Cache mode either Write-Back or Write-Through

DIMM 0 or 1:

Memory Optimization DIMM 0 or 1: Allows the memory to be configured by Auto or Manual. If Auto is selected DIMM Page Size, DIMM Size, DIMM Module Banks, and DIMM Component Banks will be grayed out.

DIMM 0 or 1 Page Size: Allows selections of Not Installed, 1,2 ,4 ,8,16 KB

DIMM 0 or 1 Size: Allows for the configuration of the Memory size to be 8M, 16M, 32M, 64M 128M, 256M, 512M

Module Banks: Allows for the configuration of the number of module banks. Options are 1 or 2

DIMM Component Banks: Allows for the configuration of the component banks Options 2 or 4

CAS Latency (SDR/DDR): Allows the configuration Column Address Select latency. The options are Auto, 2CLK/1.5CLK, 3CLK/2CLK, 4CLK/ 2.5CLK, 5CLK/3CLK and 6CLK/NA

DDR/SDR: Allows the selection of the memory type options include Auto, DDR and SDR

Refresh rate: Allows the setting of the memory refresh rate. Options include: auto, 3us, 7us, 15us, 31us, 62us and 125us

Interleave selection: Allows the setting of the interleaving to either LOI (Low Order Interleaving) to HOI (High Order Interleaving)

XOR MB0, BA0 or BA1: Allows the enable or disable of the XORing of module bank BA1 or BA0 with upper GLIU address bit. Options are Enable and Disable.

Memory Latencies: Allows the manual or auto configuration of the memory latencies

ACT2PRE: ACT to PRE Period (tRAS). Minimum number of clocks from the ACT to PRE commands on the same component bank

PRE2ACT: Pre to ACT period (tRP). Minimum number of SDRAM clocks between PRE and ACT commands

ACT2CMD: Delay time from ACT to Read/Write (tRCD). Minimum number of SDRAM clocks between ACT and Read/Write Commands

ACT2ACT: ACT(0) to ACT(1) Period (tRRD). Minimum number of SDRAM clocks between ACT and ACT commands to two different component banks within the same module bank.

REF2ACT: Refresh to Activity Delay (tRFC). Minimum number of SDCLKS 90-31) between refresh and next command, usually an activate

```

Memory and Cache Setup
Cache Enable: Enabled          Cache Mode:          Write-Back

DIMM 0                          DIMM 1
Memory Optimization DIMM0: Auto Memory Optimization DIMM 1: Auto
DIMM 0 Page Size:      Not Installed DIMM 1 Page Size:      Not Installed
DIMM 0 Size:          8 MB          DIMM 1 Size:          8 MB
DIMM 0 Module Banks: 1 bank        DIMM 1 Module Banks: 1 bank
DIMM 0 Component Banks: 2 banks    DIMM 1 Component Banks: 2 banks

CAS Latency(SDR/DDR): Auto      Memory Latencies: Auto
DDR/SDR: Auto                  ACT2PRE: 07
Refresh Rate: Auto             PRE2ACT: 3
Interleave Select: LOI         ACT2CMD: 3
                                ACT2ACT: 07
                                REF2ACT: 08

XOR BA0: Disable              XOR MB0: Disable
XOR BA1: Disable              XOR Bit Select: 18
  
```

E. System Clock/PLL and Clock Gating Configuration

The system clock/PLL allows the setting of the clocks for the AMD Geode™ system.

Clock Mode: Allows the clock speed to either be determined by the hardware strapping or manual settings. If the H/W strapping option is selected, then the manual divisor settings will be grayed out.

Manual divisor settings

Mdiv: Options from 2 to 17

Vdiv: Options from 2 to 9

FbDiv: Options from 6 to 61

The formula for the Mdiv, VDiv, and FbDiv is as follows

$$(PCI * FbDiv) / VDiv = \text{CPU speed and } (PCI * FbDiv) / MDiv = \text{GeodeLink™ speed.}$$

```

===== System Clock/PLL and Clock Gating Configuration =====
Clock Mode
Clock Determined By: Manual Settings

Manual Divisor Settings
MDiv: 02
UDiv: 2
FbDiv: 10
  
```

F. Power Management

The Power Management menu is for configuration of the BIOS's power management with relation to the OS on the platform.

BIOS PM at Boot: The BIOS PM allows setting of legacy power management mode prior to booting the system

APM Available: Allows the system to configure if the APM interface is available. The options are Yes or No

ACPI Available: Allows the system to configure if the ACPI interface is available. The options are Yes or No

S1 Internal Clock: Allows the configuration of the clocks to either run or not during S1. The options are Clocks Run During S1 or Clocks Off During S1

CPU Clock Gating: Allows the configuration of the processor clocks during power management. The options are Default, Performance, All Off, or All on

Chipset Clock Gating: Allows the configuration of the chipset clocks with the options being Enabled or Disabled

```

===== Power Management =====
Power Management Configuration
BIOS PM at Boot: Disabled

APM Available: Yes
ACPI Available: No
S1 Internal Clocks: Clocks Run During S1

CPU Clock Gating: Default

Chipset Clock Gating: Enabled

BIOS will turn on Legacy PM before booting the OS.
  
```

H. Miscellaneous Configuration

The Miscellaneous configuration screen focuses on a variety of functions, Use the (↑↓) to select the function and <enter> to change the value

Splash Screen Configuration

Splash Screen: Allows the configuration to have the splash screen displayed or not. The options are Enable or Disable

Clear Splash Screen: Allows the system to leave the splash screen on up until the operating systems clears the screen. The options are Enable or Disable

Splash Screen Timeout: Sets the time for how long the splash screen is displayed. The time is in milliseconds and goes from 0 to 65535. Enter the amount and select <enter>

Summary Screen Configuration

Summary Screen: Allows the summary screen to be either displayed or not on boot. The options are Enable or Disable

Splash Screen Timeout: Sets the time for how long the summary screen is displayed. The time is in milliseconds and goes from 0 to 65535. Enter the amount and select <enter>

Power Button Configuration: Allows the power button to be configured with ACPI mode or Instant off

PC Speaker Configuration: Allows the PC speaker to beep. The options are Enable or Disable

```

===== Miscellaneous Configuration =====
Splash Screen Configuration
Splash Screen:      Enabled
Clear Splash Screen:  Enabled
Splash Screen Timeout: 00000

Summary Screen Configuration
Summary Screen:      Enabled
Summary Screen Timeout: 00000

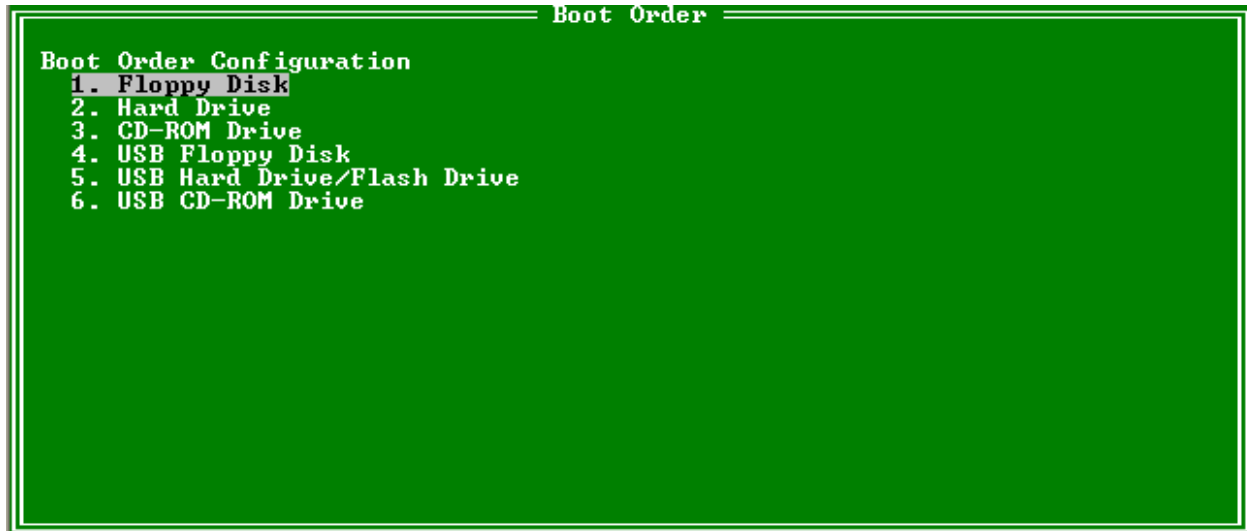
Power Button Configuration
Power Button:      Instant Off

PC Speaker Configuration
AC Beeper:      Enabled

Enable/Disable display of splash screen
  
```

O. Boot Order

The Boot Order menu allows the alteration of the devices checked for a bootable image. There are six slots for selecting the order. Use the arrow keys to select the order number and then press enter to cycle through the options. The options are None, Floppy Disk, USB Floppy Disk, Hard Drive, CD-ROM Drive, USB CD-ROM Drive, USB Hard Drive/Flash Drive.



Motherboard

C-A Drive Configuration

The drive configuration screen determines the setup for the Hard drives, Floppy, CD-ROM and Flash configurations

Hard Drive Configuration:

IDE BIOS Support: Allows the configuration of the IDE channel. The options are Enable or Disable

80-Conductor Cable Sense: Selects the GPIO that is connected to the IDE –PDIAG sense. The options are GPIO 00-17, None (disabled) , Force to 40-pin conductor cable, Force to 80-pin conductor cable

DMA/UDMA BIOS Support: This enables DMA/UDMA timings. The options are Enable and Disable

Max mode for Drive 1 or 2 : This enables the transfer mode. The options are Auto, PIO 0-4, MDMA 0 or 1, and UDMA 0-4.

Floppy configuration: Allows the Floppy to be either Enabled or Disable

CDROM Configuration: Allows the CD-ROM to be either Enabled or Disabled

Flash Configuration: Allows the use of a flash device over the IDE. The options are Enable or Disable

Chip Select 0- 3

Size: Allows the configuration of the flash chips to be disabled, 8K/16B, 16K/32B, 128K/64B, 512K/128B, 4M/256B, 8M/256B, or 256M/256B where it is Memory size / I/O size

Base: Allows the configuration of the base address. The options are PCI defaults, D2000, D4000, D6000

Type: Allows the selection of the type of flash memory. The options are Nor Mem, or NAND I/O

```

===== Drive Configuration =====
Hard Drive Configuration
IDE BIOS Support: Enabled
80-Conductor Cable Sense: Force 80 Conductor Cable
DMA/UDMA BIOS support: Disabled
Max mode for Drive 1: UDMA 0
Max mode for Drive 2: Auto

Flash Configuration                               Floppy Configuration
Flash Interface: Disabled                          Floppy Support: Disabled

                                                    CD-ROM Boot Configuration
                                                    CD-ROM Boot: Disabled

Chip Select 0 - Size: 256MB/256B Base: PCI default Type: NAND I/O
Chip Select 1 - Size: Disabled   Base: PCI default Type: Invalid Entry!
Chip Select 2 - Size: Disabled   Base: PCI default Type: Invalid Entry!
Chip Select 3 - Size: Disabled   Base: PCI default Type: Invalid Entry!

Type of Flash device.

```

C-B I/O Configuration

The I/O configuration menu enables the configuration of the serial ports on the CS5535/CS5536 parts. To select the option use the arrow keys and press enter.

UART Port A or B: Allows the selection for the address of the UART port. The options are Disabled, 0x3F8 IRQ 4, 0x2F8 IRQ 3, 0x3E8 IRQ 4, 0x2E8 IRQ3

UART Mode: Allows the selection for the mode of operation of the serial port. The options are CIR, Serial – 16550 Compatible, or Serial Extended

```

===== I/O Configuration =====
Serial Port Configuration
UART Port A: 0x3f8 IRQ 4
UART Mode: Serial - 16550 compatible

UART Port B: Disabled
UART Mode: Serial Only

Configure the 1st on-board UART.

```

C-C LPC Card Configuration

The LPC card configuration enables the configuration of each serial port and the parallel port on the LPC. To change the serial port configuration use the arrow keys (↑↓) to select the serial port and hit <enter> to change the state the choices are Disabled, 0x3F8 IRQ 4, 0x2F8 IRQ 3, 0x3E8 IRQ 4, 0x2E8 IRQ3

Parallel Port: Allows the selection of the parallel port address. The choices are disabled, 0x378, 0x278, 0x3BC.

Mode: Allows changing the parallel port mode. The options are Compatible, PS/2 Bi-directional, EPP 1.7, EPP 1.0 ECP

IRQ: Allows the configuration of the IRQ for the parallel port. The options are IRQ Disable, IRQ5, IRQ7, IRQ9, IRQ10, IRQ11

DMA: Allows the configuration of the DMA for the parallel port with the options none, Channel 1, or Channel 3

```

===== LPC CARD I/O Device Configuration =====
Serial Port 1: Disabled
Serial Port 2: Disabled

Parallel Port: 0x378
MODE: Compatible
IRQ:  IRQ 7
DMA:  None

* Floppy Configuration on Drive Configuration Menu

Configure the 1st LPC UART
  
```

C-F. Video and Flat Panel Configuration

The following menu allows you to configure video settings for the system. To change an option, select the field using the arrow keys and then select <enter> to change the value of the field. The menu system will also display the bond out option for the parts either flat panel or CRT.

Video Memory – Allows you to select the amount of video memory to reserve on the system. The options are <none> or 4MB to 16 MB

Multi-monitor Configuration – Allows the selection of the mode for the video controller when an external monitor is present. The choices include Disabled, Primary and Secondary

Flat Panel Configuration – Enables the auto or manual configuration of the flat panel.

Type: This enables the selection of the type of flat panel the choices are Auto Detect, SSTN, DSTN, TFT, LVDS. Typically the Auto Detect is recommended. (If Auto Detect is selected, then the Resolution, Bus Width and Data type will be grayed out.)

Resolution: Allows the setting of the resolution of the panel. The choices are (640x480, 800x600, 1024x768, 1152x864, 1280x1024. (Only active if Auto Detect is not selected.)

Bus Width: Allows the selection of the bus width for the panel. The options are 8, 9, 12, 16, 18, 24 – bits. (Only active if Auto Detect is not selected.)

Data Type: Allows the selection of the data type for the panel. The options are Normal or 2x. (Only active if Auto Detect is not selected.)

Refresh Rate: Allows the selection of the monitors refresh rate. The options are 60, 70, 72, 75, and 85Hz

HSYNC Polarity: Selects the active polarity of the HSYNC signal to the panel. The options are Active Low or Active High

VSYNC Polarity: Selects the active polarity of the VSYNC signal to the panel. The options are Active Low or Active High

LP Active Period: Selects the active period of the LDE/MOD (LP) signal. The options are Free Running and Active Only

SHFCLK Active Period: Selects the active period of the SHFCHK signal. The options are Free Running and Active Only

Backlight Configuration: Allows the configuration of the backlight

Backlight Enable: Selects the if the backlight is Enabled or Disabled

Initial Brightness: Selects the initial brightness of the panel. The options are Last Value, 0%(off), 10%, 20%, 30%, 40%,50%, 60%, 70%, 80%, 90%, 100% (full on)

```

===== Video Configuration =====
Video Memory: 8 MB                      GX2 Flat Panel or CRT Bond Out
                                           GX2 Mode: Flat Panel
Multi-Monitor Configuration
  Onboard Multi-Monitor Mode: Disabled

Flat Panel Configuration
  Type: Auto Detect                      HSYNC Polarity: Active low
  Resolution: 800x600                   USYNC Polarity: Active low
  Bus Width: 18-bit                     LP Active Period: Free running
  Data Type: Normal                     SHFCLK Active Period: Free running
  Refresh Rate: 60 Hz

Backlight Configuration
  Backlight Enable: Disabled
  Initial Brightness: Last Value

Select the amount of memory to reserve for video
  
```

C-G PCI Configuration

The following menu system allows the configuration of the PCI interrupts. Select the PCI interrupt desired to change and hit <enter> to cycle through the IRQs.

For the USB 2.0 the options are as follows:

OHCI: Enable or Disable OHCI Controller

EHCI: Enable or Disable EHCI Controller

UDC: USB Device Controller Enable or Disable

OTG: On-The-GO Enable or Disable

Overcurrent Reporting: Enable or Disable over current reporting

Port 4 Assignment: Determines the functionality of the USB port 4. The options are Not Used, Device and Host

```

===== PCI Configuration =====

PCI Interrupt Steering
PCI INTA#: Disabled
PCI INTB#: Disabled
PCI INTC#: Disabled
PCI INTD#: Disabled

USB 2.0 Settings
OHCI: Disabled
EHCI: Disabled
UDC: Disabled
OTG: Disabled
Overcurrent reporting: Disabled
Port 4 assignment: Host

Enable/Disable INTA# to IRQ steering
  
```

C-T Thermal Configuration

The Thermal Configuration screen enables the setting of the ambient and CPU high temperature points as well as reads the current state of the ambient and CPU temperature. The values are in Celsius. To change the temperature set point, use the Arrow keys (↑↓) to select the option and press <enter>. Once selected type in the new Celsius value and press <enter> again.

```
===== Thermal Configuration =====
Thermal SetPoints
Ambient High Temperature Setpoint: 45
CPU High Temperature Setpoint:    80

Reading Current Temperature...
Current Ambient Temperature:    000
Current CPU Temperature:       000

Setting the Local HIGH temperature (Celsius) to LM82.
```

Conclusion

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